

# MCD 0,5/ 8-G1-2,5 HT BK - PCB header



1961203

<https://www.phoenixcontact.com/us/products/1961203>

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The figure shows a 10-position version of the product

PCB headers, nominal cross section: 0.5 mm<sup>2</sup>, color: black, nominal current: 4 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of potentials: 16, number of rows: 2, number of positions: 8, number of connections: 16, product range: MCD 0,5/..-G1-HT, pitch: 2.5 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 3.8 mm, number of solder pins per potential: 1, plug-in system: COMBICON FK-MC 0,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: packed in cardboard, Standard component made of highly temperature resistant plastic; suitable for reflow process. User information and design recommendations on Through Hole Reflow Technology can be found at: "Downloads".

## Your advantages

- Designed for integration into the SMT soldering process
- Conductor connection on several levels enables higher contact density

## Commercial data

Item number	1961203
Packing unit	50 pc
Minimum order quantity	50 pc
Note	Made to order (non-returnable)
Sales key	AA01
Product key	AAATHA
GTIN	4017918912512
Weight per piece (including packing)	9.032 g
Weight per piece (excluding packing)	9 g
Customs tariff number	85366930
Country of origin	DE

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## Technical data

### Product properties

Product type	PCB headers
Product family	MCD 0,5/...-G1-HT
Product line	COMBICON Connectors XS
Type	Component suitable for through hole reflow
Number of positions	8
Pitch	2.5 mm
Number of connections	16
Number of rows	2
Number of potentials	16
Mounting type	without
Pin layout	Linear pinning
Solder pins per potential	1

### Electrical properties

#### Properties

Nominal current $I_N$	4 A
Nominal voltage $U_N$	160 V
Contact resistance	3 mΩ
Rated voltage (III/3)	32 V
Rated surge voltage (III/3)	1.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	160 V
Rated surge voltage (II/2)	2.5 kV

### Mounting

Mounting type	THR soldering / wave soldering
Pin layout	Linear pinning

### Material specifications

#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface contact area (middle layer)	Nickel (1 μm - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface soldering area (middle layer)	Nickel (1 μm - 3 μm Ni)

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## Material data - housing

Color (Housing)	black (9005)
Insulating material	PA
Insulating material group	IIIa
CTI according to IEC 60112	325
Flammability rating according to UL 94	V0

## Dimensions

Dimensional drawing	
Pitch	2.5 mm
Width [w]	21.9 mm
Height [h]	25.65 mm
Length [l]	17.5 mm
Installed height	21.85 mm
Solder pin length [P]	3.8 mm
Pin dimensions	0.8 x 0.8 mm

## PCB design

Pin spacing	2.50 mm
Hole diameter	1.4 mm

## Mechanical tests

### Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

### Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

### Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

### Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

### Contact holder in insert

Specification	IEC 60512-15-1:2008-05
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Contact holder in insert Requirements >20 N	Test passed
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## Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	7 N
Withdraw strength per pos. approx.	6 N

## Electrical tests

### Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	12

### Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

### Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 325
Rated insulation voltage (III/3)	32 V
Rated surge voltage (III/3)	1.5 kV
minimum clearance value - non-homogenous field (III/3)	0.8 mm
minimum creepage distance (III/3)	1.3 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	160 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

## Environmental and real-life conditions

### Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R <sub>1</sub>	3 mΩ
Contact resistance R <sub>2</sub>	3.2 mΩ
Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 MΩ

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## Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm <sup>3</sup> SO <sub>2</sub> on 300 dm <sup>3</sup> /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

## Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

## Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

## Packaging specifications

Type of packaging	packed in cardboard
Outer packaging type	Dry bag

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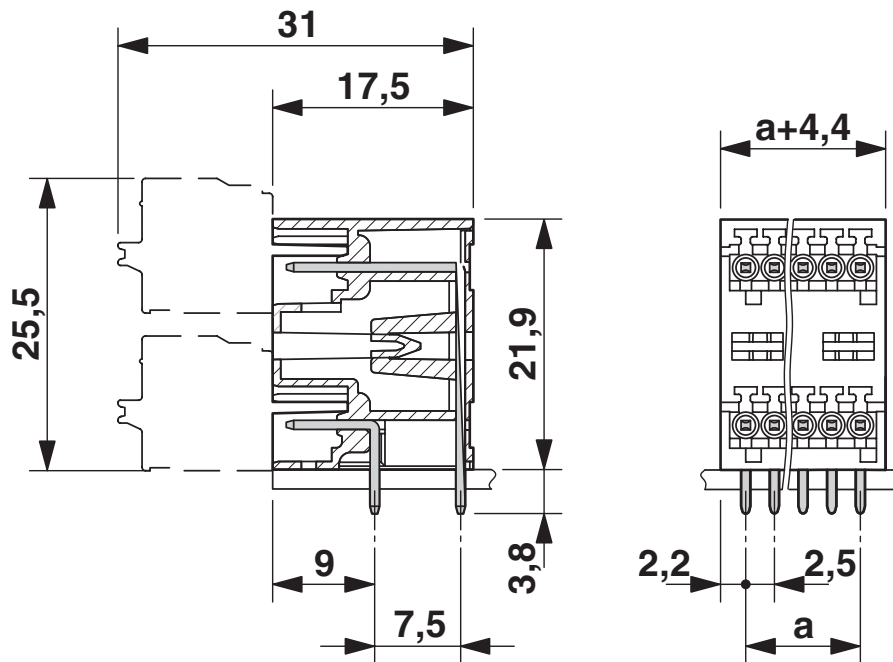


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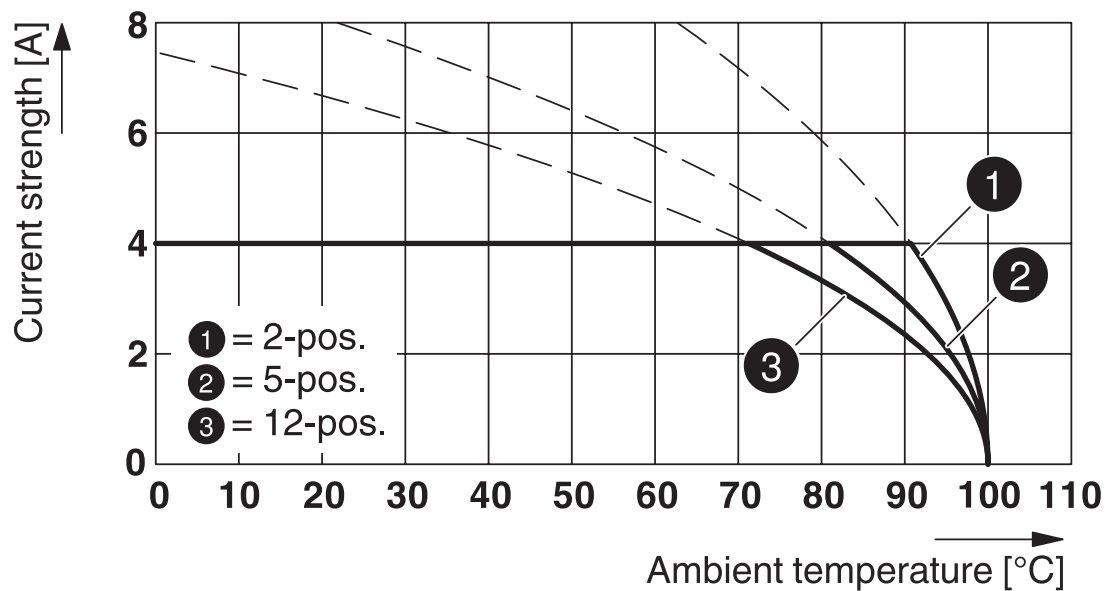
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## Drawings

Dimensional drawing



Diagram



Type: FK-MC 0,5/...-ST-2,5 with MCD 0,5/...-G1-2,5 HT BK

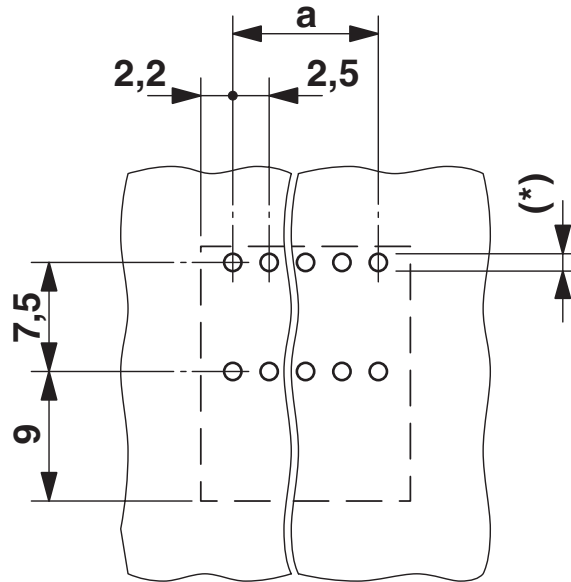
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Drilling plan/solder pad geometry



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## Classifications

### ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

### ETIM

ETIM 10.0	EC002637
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### UNSPSC

UNSPSC 21.0	39121400
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## Environmental product compliance

### EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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### China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

### EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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### EF3.1 Climate Change

CO2e kg	0.135 kg CO2e
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